Transistors

# 2SD2216G

### Silicon NPN epitaxial planar type

For general amplification Complementary to 2SB1462G

#### Features

- $\bullet$  High forward current transfer ratio  $h_{F\!E}$
- $\bullet$  Low collector-emitter saturation voltage  $V_{\mbox{CE(sat)}}$
- SS-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing.

Absolute Maximum Hatings $T_a = 25$ C						
Parameter	Symbol Rating		Unit			
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	60	V			
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	50	V			
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	7	V			
Collector current	I <sub>C</sub>	100	mA			
Peak collector current	I <sub>CP</sub>	200	mA			
Collector power dissipation	P <sub>C</sub>	125	mW			
Junction temperature	Tj	125	°C			
Storage temperature	T <sub>stg</sub>	-55 to +125	°C			

#### Absolute Maximum Batings T = 25°C

#### Package

- Code
- SSMini3-F3
- Marking Symbol: Y
- Pin Name
  - 1: Base
  - 2: Emitter
- 3: Collector

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{\rm C} = 10 \ \mu {\rm A}, \ I_{\rm E} = 0$	60	SOL		V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = 2 \text{ mA}, I_{\rm B} = 0$	50	0-		V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	$I_{\rm E} = 10 \ \mu A, I_{\rm C} = 0$	7			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 20 V, I_E = 0$			0.1	μΑ
Collector-emitter cutoff current (Base open)	I <sub>CEO</sub>	$V_{CE} = 10 \text{ V}, I_B = 0$			100	μΑ
Forward current transfer ratio	h <sub>FE1</sub> *2	$V_{CE} = 10 \text{ V}, I_C = 2 \text{ mA}$	160		460	_
	h <sub>FE2</sub> *1	$V_{CE} = 2 \text{ V}, \text{ I}_{C} = 100 \text{ mA}$	90			
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = 100 \text{ mA}, I_{\rm B} = 10 \text{ mA}$		0.1	0.3	V
Transition frequency	f <sub>T</sub>	$V_{CB} = 10 \text{ V}, I_E = -2 \text{ mA}, f = 200 \text{ MHz}$		150		MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		3.5		pF

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

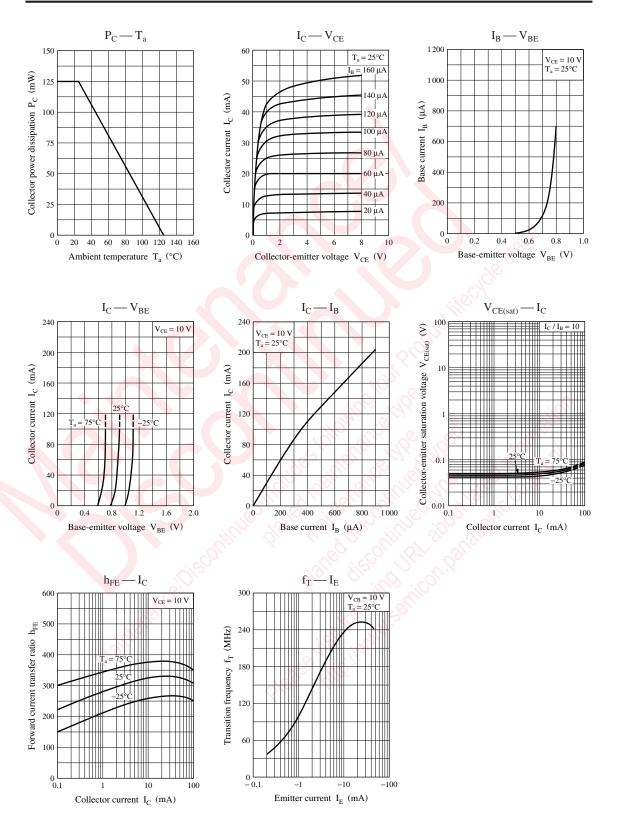
2. \*1: Pulse measurement

\*2: Rank classification

Rank	Q	R	S	No rank
$h_{\rm FE1}$	160 to 260	210 to 340	290 to 460	180 to 390

Product of no-rank is not classified and have no marking symbol for rank.

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